

## General Description

The WSD75100DN56 is the highest performance trench N-Ch MOSFET with extreme high cell density , which provide excellent  $R_{DS(on)}$  and gate charge for most of the synchronous buck converter applications .

The WSD75100DN56 meet the RoHS and Green Product requirement , 100% EAS guaranteed with full function reliability approved.

## Features

- Reliable and Rugged
- Lead Free and Green Devices Available (RoHS Compliant)

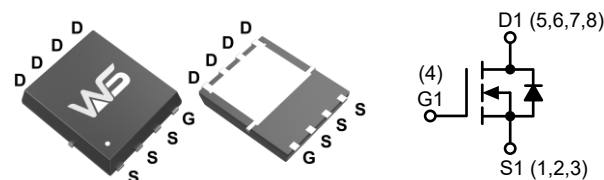
## Product Summary

$BV_{DSS}$	$R_{DS(on)}$	$I_D$
75V	5.3m $\Omega$	100A

## Applications

- DC-DC converter switching for Networkong
- General purpose switching

## DFN5X6-8L Pin Configuration



## Absolute Maximum Ratings ( $T_A=25^{\circ}\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	75	V
$V_{GS}$	Gate-Source Voltage	$\pm 25$	V
$T_J$	Maximum Junction Temperature	150	$^{\circ}\text{C}$
$I_D$	Storage Temperature Range	-55 to 150	$^{\circ}\text{C}$
$I_S$	Diode Continuous Forward Current, $T_C=25^{\circ}\text{C}$	50	A
$I_D$	Continuous Drain Current, $V_{GS}=10\text{V}$ , $T_C=25^{\circ}\text{C}$	100	A
	Continuous Drain Current, $V_{GS}=10\text{V}$ , $T_C=100^{\circ}\text{C}$	73	A
$I_{DM}$	Pulsed Drain Current , $T_C=25^{\circ}\text{C}$	400	A
$P_D$	Maximum Power Dissipation, $T_C=25^{\circ}\text{C}$	155	W
	Maximum Power Dissipation, $T_C=100^{\circ}\text{C}$	62	W
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient , $t = 10\text{s}$	20	$^{\circ}\text{C}$
	Thermal Resistance-Junction to Ambient , Steady State	60	$^{\circ}\text{C}$
$R_{\theta JC}$	Thermal Resistance-Junction to Case	0.8	$^{\circ}\text{C}$
$I_{AS}$	Avalanche Current, Single pulse, $L=0.5\text{mH}$	30	A
$E_{AS}$	Avalanche Energy, Single pulse, $L=0.5\text{mH}$	225	mJ

**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	75	---	---	V
$\Delta BV_{DSS}/\Delta T_J$	$BV_{DSS}$ Temperature Coefficient	Reference to $25^\circ\text{C}$ , $I_D=1mA$	---	0.043	---	V/ $^\circ\text{C}$
$R_{DS(ON)}$	Static Drain-Source On-Resistance <sup>2</sup>	$V_{GS}=10V, I_D=25A$	---	5.3	6.4	m $\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	2.0	3.0	4.0	V
$\Delta V_{GS(th)}$	$V_{GS(th)}$ Temperature Coefficient		---	-6.94	---	mV/ $^\circ\text{C}$
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=48V, V_{GS}=0V, T_J=25^\circ\text{C}$	---	---	2	$\mu A$
		$V_{DS}=48V, V_{GS}=0V, T_J=55^\circ\text{C}$	---	---	10	
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	$\pm 100$	nA
$g_{fs}$	Forward Transconductance	$V_{DS}=5V, I_D=20A$	---	50	---	S
$R_g$	Gate Resistance	$V_{DS}=0V, V_{GS}=0V, f=1MHz$	---	1.0	2	$\Omega$
$Q_g$	Total Gate Charge (10V)	$V_{DS}=20V, V_{GS}=10V, I_D=40A$	---	65	85	nC
$Q_{gs}$	Gate-Source Charge		---	20	---	
$Q_{gd}$	Gate-Drain Charge		---	17	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=30V, V_{GEN}=10V, R_G=1\Omega, I_D=1A, RL=15\Omega.$	---	14	26	ns
$T_r$	Rise Time		---	27	49	
$T_{d(off)}$	Turn-Off Delay Time		---	37	67	
$T_f$	Fall Time		---	60	108	
$C_{iss}$	Input Capacitance	$V_{DS}=20V, V_{GS}=0V, f=1MHz$	3450	3500	4550	pF
$C_{oss}$	Output Capacitance		245	395	652	
$C_{rss}$	Reverse Transfer Capacitance		100	195	250	

**Guaranteed Avalanche Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
EAS	Single Pulse Avalanche Energy <sup>5</sup>	$V_{DD}=25V, L=0.5mH, I_{AS}=30A$	198	---	---	mJ

**Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_S$	Continuous Source Current <sup>1,6</sup>	$V_G=V_D=0V$ , Force Current	---	---	50	A
$I_{SM}$	Pulsed Source Current <sup>2,6</sup>		---	---	100	A
$V_{SD}$	Diode Forward Voltage <sup>2</sup>	$V_{GS}=0V, I_S=20A, T_J=25^\circ\text{C}$	---	---	1.4	V

Note :

1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 20Z copper,  $t < 10\text{sec}$ .

2.The data tested by pulsed, pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$

3.The EAS data shows Max. rating. The test condition is  $V_{DD}=25V, V_{GS}=10V, L=0.5mH, I_{AS}=30A$

4.The power dissipation is limited by  $150^\circ\text{C}$  junction temperature

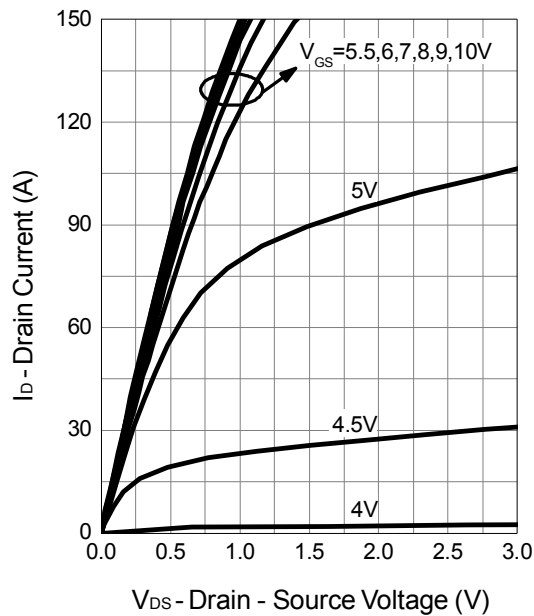
5.The Min. value is 100% EAS tested guarantee.

6.The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.

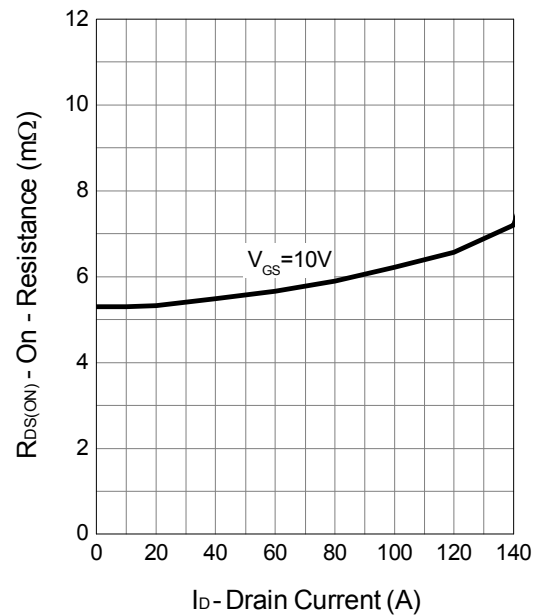
7.Package limitation current is 100A.

## Typical Characteristics

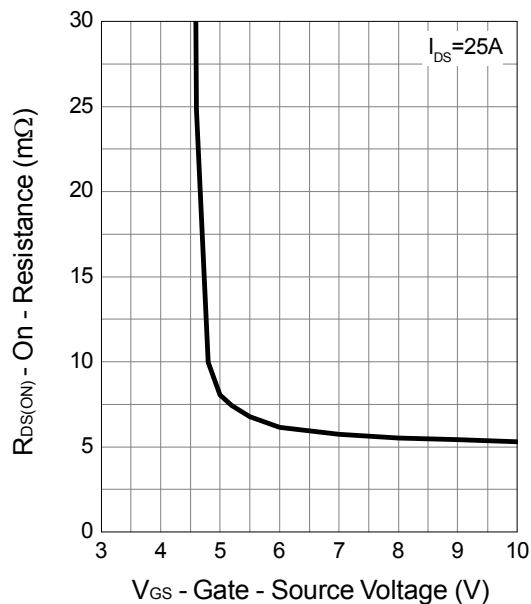
**Output Characteristics**



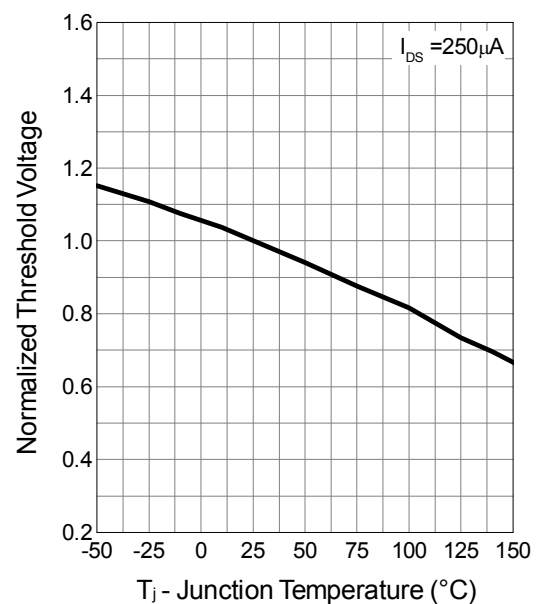
**Drain-Source On Resistance**



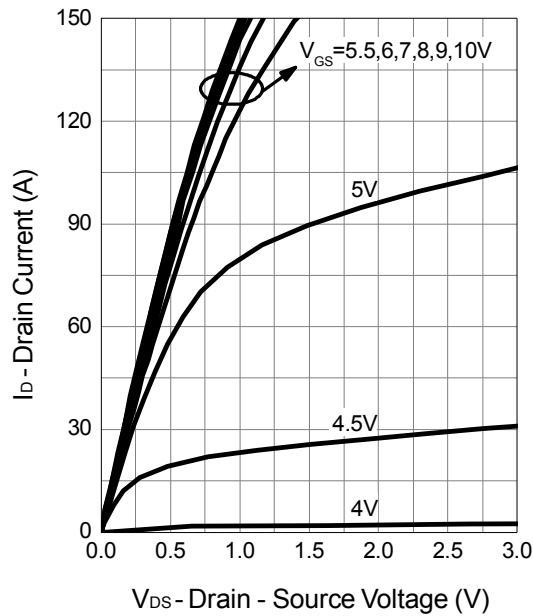
**Gate-Source On Resistance**



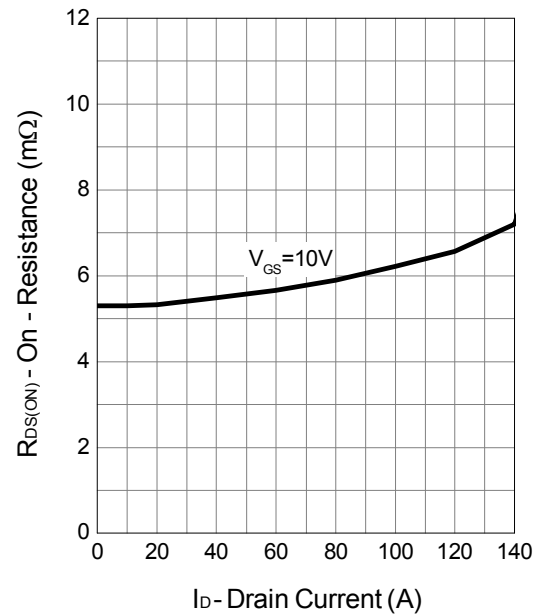
**Gate Threshold Voltage**



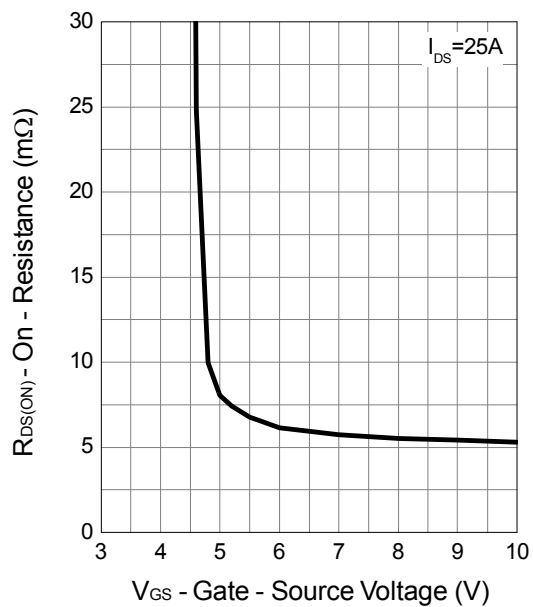
**Output Characteristics**



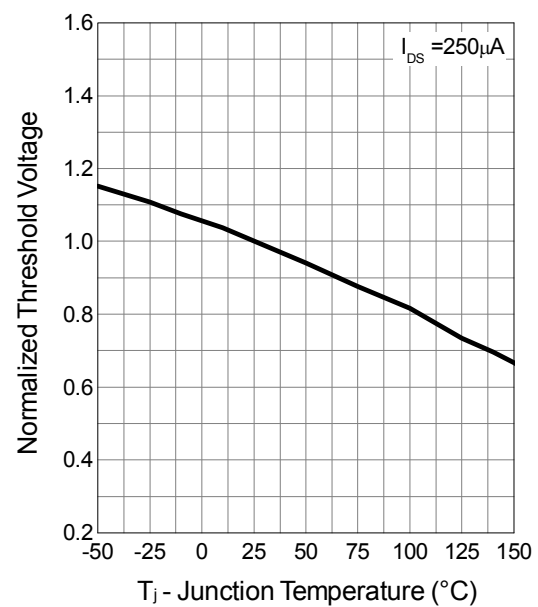
**Drain-Source On Resistance**



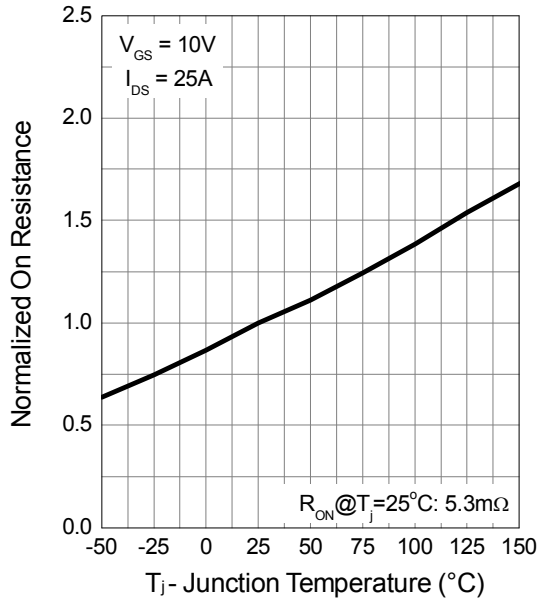
**Gate-Source On Resistance**



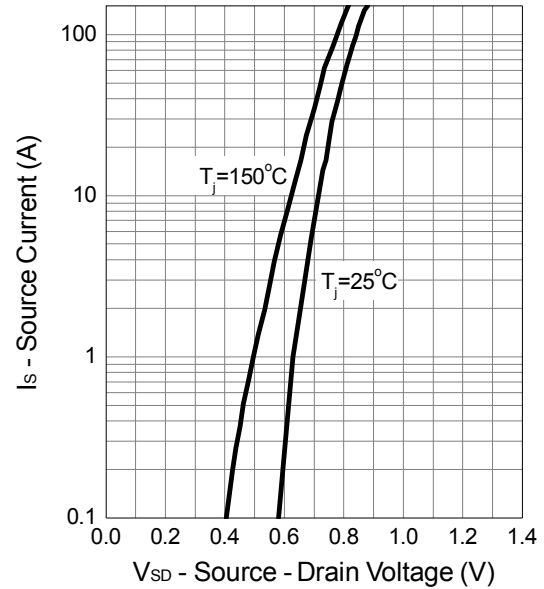
**Gate Threshold Voltage**



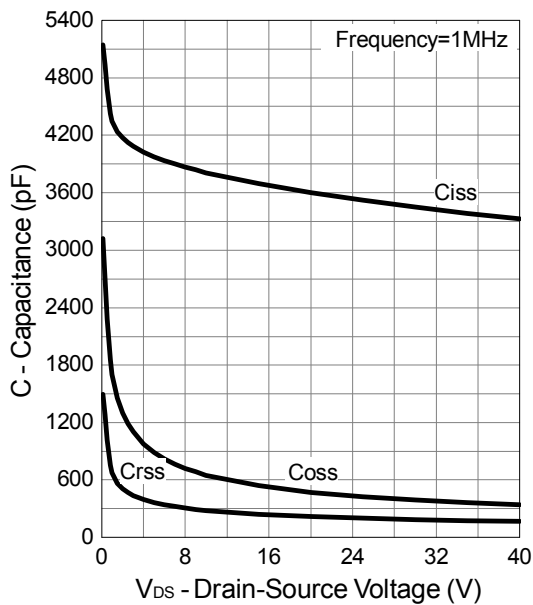
**Drain-Source On Resistance**



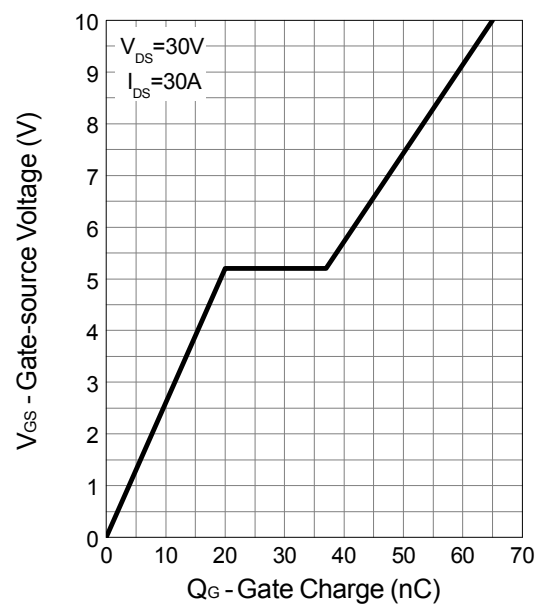
**Source-Drain Diode Forward**



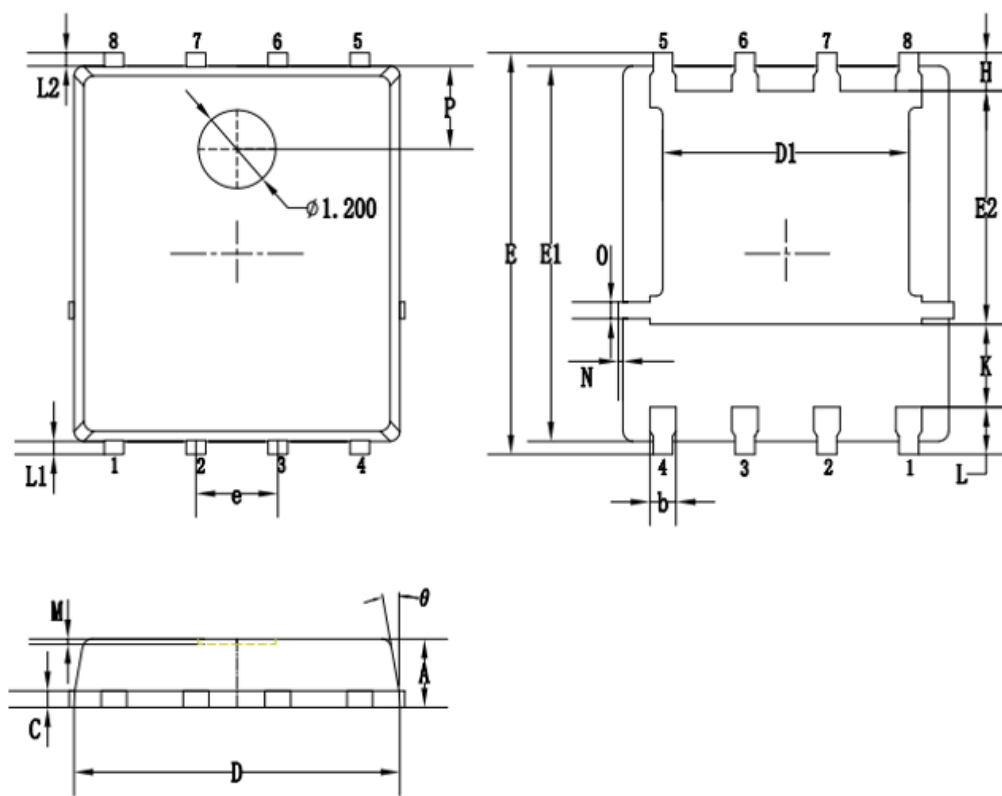
**Capacitance**



**Gate Charge**



## Packaging information



SYMBOLS	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.90	1.05	1.20
b	0.35	0.40	0.50
C	0.20	0.25	0.35
D	4.90	5.05	5.20
D1	3.72	3.82	3.92
E	6.00	6.15	6.30
E1	5.60	5.75	5.90
E2	3.47	3.57	3.67
e	1.27 BSC.		
H	0.48	0.58	0.68
K	1.17	1.27	1.37
L	0.64	0.74	0.84
L1/L2	0.20 REF.		
$\theta$	8°	10°	12°
M	0.08 REF.		
N	0	-	0.15
O	0.25 REF.		
P	1.28 REF.		

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